

## **C1210X271KGRACTU**

Aliases (C1210X271KGRAC7800) SMD Comm X7R HV Flex, Ceramic, 270 pF, 10%, 2,000 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 1210, 1.5 mm



General Information	
Series	SMD Comm X7R HV Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Temperature Stable
Features	FT-CAP, Temperature Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	105 mg
Shelf Life	78 Weeks
MSL	1

270 pF

100 GOhms

Dimensions	
Chip Size	1210
L	3.3mm +/-0.4mm
W	2.6mm +/-0.3mm
Т	2.1mm +/-0.20mm
S	1.5mm MIN
В	0.6mm +/-0.25mm

3.3mm +/-0.4mm	Measurement Condition	1 kHz 1.0Vrms
2.6mm +/-0.3mm	Tolerance	10%
2.1mm +/-0.20mm	Voltage DC	2000 VDC
1.5mm MIN	Dielectric Withstanding Voltage	2,400 VDC
0.6mm +/-0.25mm	Temperature Range	-55/+125°C
	Temp. Coefficient	X7R
T&R, 180mm, Plastic Tape	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
2000	Dissipation Factor	2.5%1kHz1.0Vrms
	Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours

Insulation Resistance

**Specifications** 

Capacitance

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2000

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